# **Advanced Micro Devices**

Advanced Micro Devices, Inc.





Old AMD Headquarters (Sunnyvale, California)

<u>Type</u>	Public
<u>Traded as</u>	<ul> <li><u>NASDAQ</u>: <u>AMD</u></li> <li><u>NASDAQ 100</u> component</li> <li><u>S&amp;P 500</u> component</li> </ul>
<u>ISIN</u>	<u>US0079031078</u>
Industry	Semiconductors
Predecessor	ATI Technologies, NexGen, Alchemy Semiconductor 🧨
Founded	May 1, 1969; 50 years ago
Founder	Jerry Sanders
Headquarters	<u>Santa Clara, California</u> , U.S.
Area served	Worldwide
Key people	<ul> <li><u>Lisa Su (President</u> and <u>CEO</u>)</li> <li><u>John Edward Caldwell</u> (<u>Chairman</u>)</li> </ul>

Products	<ul> <li><u>Microprocessors</u></li> <li><u>Graphics processing units</u></li> </ul>
Revenue	▲ <u>US\$</u> 6.73 billion (2019) <sup>[1]</sup>
<u>Operating</u> <u>income</u>	▲US\$631 million (2019) <sup>[1]</sup>
<u>Net income</u>	▲US\$341 million (2019) <sup>[1]</sup>
Total assets	▲US\$4.556 billion (2018) <sup>[1]</sup>
<u> Fotal equity</u>	▲US\$1.266 billion (2018) <sup>[1]</sup>
Number of employees	10,100 <sup>[2]</sup> (2018)
Website	www.amd.com

Mark Papermaster (CTO)

Advanced Micro Devices, Inc. (AMD) is an American <u>multinational semiconductor company</u> based in <u>Santa Clara County</u>, <u>California</u> that develops <u>computer processors</u> and related technologies for business and <u>consumer markets</u>. While initially it manufactured its own processors, the company later outsourced its manufacturing, a practice known as going <u>fabless</u>, after <u>GlobalFoundries</u> was spun off in 2009. AMD's main products include <u>microprocessors</u>, <u>motherboard chipsets</u>, <u>embedded processors</u> and <u>graphics processors</u> for <u>servers</u>, <u>workstations</u>, personal computers and <u>embedded system</u> applications.

AMD is the second-largest supplier and only significant rival to <u>Intel</u> in the market for <u>x86</u>-based microprocessors. Since acquiring <u>ATI</u> in 2006, AMD and its competitor <u>Nvidia</u> have maintained a <u>duopoly</u> in the discrete <u>graphics processing unit</u> (GPU) market.<sup>[3]</sup>

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# History



AMD's campus in <u>Markham</u>, <u>Ontario</u>, Canada, formerly <u>ATI</u> headquarters, now known as AMD Markham.



AMD's LEED-certified Lone Star campus in Austin, Texas

### First twelve years

Advanced Micro Devices was formally incorporated on May 1, 1969, by <u>Jerry Sanders</u>, along with seven of his colleagues from <u>Fairchild Semiconductor</u>.<sup>[4][5]</sup> Sanders, an <u>electrical engineer</u> who was the director of marketing at Fairchild, had, like many Fairchild executives, grown frustrated with the increasing lack of support, opportunity, and flexibility within the company, and decided to leave to start his own <u>semiconductor</u> company.<sup>[6]</sup> The previous year <u>Robert</u> <u>Noyce</u>, who had developed the first silicon <u>integrated circuit</u> in 1959 at Fairchild,<sup>[7]</sup> had left Fairchild together with <u>Gordon Moore</u> and founded the semiconductor company <u>Intel</u> in July 1968.<sup>[8]</sup>

In September 1969, AMD moved from its temporary location in <u>Santa Clara</u> to <u>Sunnyvale</u>, California.<sup>[9]</sup> To immediately secure a customer base, AMD initially became a <u>second source</u> supplier of microchips designed by Fairchild and <u>National Semiconductor</u>.<sup>[10][11]</sup> AMD first focused on producing logic chips.<sup>[12]</sup> The company guaranteed quality control to <u>United States</u> <u>Military Standard</u>, an advantage in the early computer industry since unreliability in microchips was a distinct problem that customers – including <u>computer manufacturers</u>, the <u>telecommunications industry</u>, and instrument manufacturers – wanted to avoid.<sup>[10][13][14][15]</sup>

In November 1969, the company manufactured its first product, the Am9300, a <u>4-bit MSI shift</u> register, which began selling in 1970.<sup>[15][16]</sup> Also in 1970, AMD produced its first proprietary product, the Am2501 logic counter, which was highly successful.<sup>[17][18]</sup> Its best-selling product in 1971 was the Am2505, the fastest <u>multiplier</u> available.<sup>[17][19]</sup>

In 1971, AMD entered the <u>RAM</u> chip market, beginning with the Am3101, a <u>64-bit</u> bipolar RAM.<sup>[19][20]</sup> That year AMD also greatly increased the sales volume of its linear integrated circuits, and by year end the company's total annual sales reached <u>US\$</u>4.6 million.<sup>[17][21]</sup>

AMD went public in September 1972.<sup>[10][22][23]</sup> The company was a second source for Intel <u>MOS/LSI</u> circuits by 1973, with products such as Am14/1506 and Am14/1507, dual 100-bit dynamic shift registers.<sup>[24][25]</sup> By 1975, AMD was producing 212 products – of which 49 were proprietary, including the Am9102 (a <u>static N-channel</u> 1024-bit RAM)<sup>[26]</sup> and three low-power <u>Schottky MSI</u> circuits: Am25LS07, Am25LS08, and Am25LS09.<sup>[27]</sup>

Intel had created the first <u>microprocessor</u>, its 4-bit <u>4004</u>, in 1971.<sup>[28][29]</sup> By 1975, AMD entered the microprocessor market with the <u>Am9080</u>, a <u>reverse-engineered</u> clone of the <u>Intel</u> <u>8080</u>,<sup>[30][31][32]</sup> and the <u>Am2900 bit-slice</u> microprocessor family.<sup>[31]</sup> When Intel began installing <u>microcode</u> in its microprocessors in 1976, it entered into a <u>cross-licensing</u> agreement with AMD, granting AMD a copyright license to the microcode in its microprocessors and peripherals, effective October 1976.<sup>[27][33][34][35][36]</sup>

In 1977, AMD entered into a joint venture with <u>Siemens</u>, a German engineering conglomerate wishing to enhance its technology expertise and enter the U.S. market.<sup>[37]</sup> Siemens purchased 20% of AMD's stock, giving AMD an infusion of cash to increase its product lines.<sup>[37][38][39]</sup> That year the two companies also jointly established <u>Advanced Micro Computers</u> (AMC), located in Silicon Valley and in Germany, giving AMD an opportunity to enter the <u>microcomputer</u> development and manufacturing field,<sup>[37][40][41][42]</sup> in particular based on AMD's second-source <u>Zilog Z8000</u> microprocessors.<sup>[43][44]</sup> When the two companies' vision for Advanced Micro Computers diverged, AMD bought out Siemens' stake in the U.S. division in 1979.<sup>[45][46]</sup> AMD closed its Advanced Micro Computers subsidiary in late 1981, after switching focus to manufacturing second-source Intel x86 microprocessors.<sup>[43][47][48]</sup>

Total sales in <u>fiscal year</u> 1978 topped \$100 million,<sup>[40]</sup> and in 1979, AMD debuted on the <u>New</u> <u>York Stock Exchange</u>.<sup>[18]</sup> In 1979, production also began in AMD's new semiconductor <u>fab</u> in <u>Austin, Texas</u>,<sup>[18]</sup> the company already had overseas assembly facilities in <u>Penang</u> and <u>Manila</u>,<sup>[49]</sup> and it began construction on a semiconductor fab in <u>San Antonio</u> in 1981.<sup>[50]</sup> In 1980, AMD began supplying semiconductor products for <u>telecommunications</u>, an industry undergoing rapid expansion and innovation.<sup>[51]</sup>

# Technology exchange agreement with Intel

Intel had introduced the first <u>x86</u> microprocessors in 1978.<sup>[52]</sup> In 1981, <u>IBM</u> created its <u>PC</u>, and wanted Intel's x86 processors, but only under the condition that Intel also provide a second-source manufacturer for its patented x86 microprocessors.<sup>[13]</sup> Intel and AMD entered into a 10-year technology exchange agreement, first signed in October 1981<sup>[47][53]</sup> and formally executed in February 1982.<sup>[36]</sup> The terms of the agreement were that each company could acquire the right to become a second-source manufacturer of semiconductor products developed by the other; that is, each party could "earn" the right to manufacture and sell a product developed by the other, if agreed to, by exchanging the manufacturing rights to a product of equivalent technical complexity. The technical information and licenses needed to make and sell a part would be

exchanged for a royalty to the developing company.<sup>[35]</sup> The 1982 agreement also extended the 1976 AMD–Intel cross-licensing agreement through 1995.<sup>[35][36]</sup> The agreement included the right to invoke arbitration of disagreements, and after five years the right of either party to end the agreement with one year's notice.<sup>[35]</sup> The main result of the 1982 agreement was that AMD became a second-source manufacturer of Intel's x86 microprocessors and related chips, and Intel provided AMD with database tapes for its <u>8086</u>, <u>80186</u>, and <u>80286</u> chips.<sup>[36]</sup>

Beginning in 1982, AMD began volume-producing second-source Intel-licensed 8086, 8088, 80186, and 80188 processors, and by 1984 its own <u>Am286</u> clone of Intel's 80286 processor, for the rapidly growing market of IBM PCs and <u>IBM clones</u>.<sup>[13][54]</sup> It also continued its successful concentration on proprietary <u>bipolar</u> chips.<sup>[55]</sup> In 1983, it introduced INT.STD.1000, the highest manufacturing quality standard in the industry.<sup>[15][50]</sup>

The company continued to spend greatly on research and development,<sup>[56]</sup> and in addition to other breakthrough products, created the world's first 512K <u>EPROM</u> in 1984.<sup>[57]</sup> That year AMD was listed in the book *The 100 Best Companies to Work for in America*,<sup>[50][58]</sup> and based on 1984 income it made the *Fortune* 500 list for the first time in 1985.<sup>[59][60]</sup>

By mid-1985, however, the microchip market experienced a severe downturn, mainly due to long-term aggressive trade practices (dumping) from Japan, but also due to a crowded and non-innovative chip market in the U.S.<sup>[61]</sup> AMD rode out the mid-1980s crisis by aggressively innovating and modernizing,<sup>[62]</sup> devising the Liberty Chip program of designing and manufacturing one new chip or chip set per week for 52 weeks in <u>fiscal year</u> 1986,<sup>[50][63]</sup> and by heavily lobbying the U.S. government until sanctions and restrictions were put in place to prevent predatory Japanese pricing.<sup>[64]</sup> During this time period, AMD withdrew from the <u>DRAM</u> market,<sup>[65]</sup> and at the same time made some headway into the <u>CMOS</u> market, which it had lagged in entering, having focused instead on bipolar chips.<sup>[66]</sup>

AMD had some success in the mid-1980s with the AMD7910 and AMD7911 "World Chip" <u>FSK</u> modem, one of the first multi-standard devices that covered both Bell and <u>CCITT</u> tones at up to 1200 baud half duplex or 300/300 full duplex.<sup>[67]</sup> Beginning in 1986, AMD embraced the perceived shift toward <u>RISC</u> with their own <u>AMD Am29000</u> (29k) processor;<sup>[68]</sup> the 29k survived as an <u>embedded processor</u>.<sup>[69][70]</sup> The company also increased its <u>EPROM</u> memory market share in the late 1980s.<sup>[71]</sup> Throughout the 1980s, AMD was a second-source supplier of Intel x86 processors. In 1991, it introduced its own 386-compatible <u>Am386</u>, an AMD-designed chip. Creating its own chips, AMD began to compete directly with Intel.<sup>[72]</sup>

AMD had a large and successful <u>flash memory</u> business, even during the <u>dotcom bust</u>.<sup>[73]</sup> In 2003, to divest some manufacturing and aid its overall cash flow, which was under duress from aggressive microprocessor competition from Intel, AMD spun off its flash memory business and manufacturing into <u>Spansion</u>, a joint venture with <u>Fujitsu</u>, which had been co-manufacturing flash memory with AMD since 1993.<sup>[74][75]</sup> AMD divested itself of Spansion in December 2005, in order to focus on the microprocessor market, and Spansion went public in an IPO.<sup>[76]</sup>

#### **Acquisition of ATI**

AMD announced the acquisition of the graphics processor company <u>ATI Technologies</u> on July 24, 2006. AMD paid \$4.3 billion in cash and 58 million shares of its <u>stock</u>, for a total of approximately \$5.4 billion. The transaction completed on October 25, 2006.<sup>[77]</sup> On August 30, 2010, AMD announced that it would retire the ATI brand name for its graphics chipsets in favor of the AMD brand name.<sup>[78][79]</sup>

In October 2008, AMD announced plans to spin off manufacturing operations in the form of a multibillion-dollar joint venture with <u>Advanced Technology Investment Co.</u>, an investment company formed by the government of <u>Abu Dhabi</u>. The new venture is called <u>GlobalFoundries</u> <u>Inc.</u> The partnership and spin-off gave AMD an infusion of cash and allowed AMD to focus solely on chip design.<sup>[80]</sup> To assure the Abu Dhabi investors of the new venture's success, CEO <u>Hector Ruiz</u> stepped down as CEO of AMD in July 2008, while remaining Executive Chairman, in preparation for becoming Chairman of Global Foundries in March 2009.<sup>[81][82]</sup> President and COO <u>Dirk Meyer</u> became AMD's CEO.<sup>[83]</sup> Recessionary losses necessitated AMD cutting 1,100 jobs in 2009.<sup>[84]</sup>

In August 2011, AMD announced that former <u>Lenovo</u> executive <u>Rory Read</u> would be joining the company as CEO, replacing Meyer.<sup>[85]</sup> AMD announced in November 2011 plans to lay off more than 10% (1,400) of its employees from across all divisions worldwide.<sup>[86]</sup> In October 2012, it announced plans to lay off an additional 15% of its workforce to reduce costs in the face of declining sales revenue.<sup>[87]</sup>

AMD acquired the low-power server manufacturer <u>SeaMicro</u> in early 2012, with an eye to bringing out an <u>ARM architecture</u> server chip.<sup>[88]</sup>

On October 8, 2014, AMD announced that Rory Read had stepped down after three years as president and chief executive officer.<sup>[89]</sup> He was succeeded by Lisa Su, a key lieutenant who had been serving as chief operating officer since June.<sup>[90]</sup>

On October 16, 2014, AMD announced a new restructuring plan along with its Q3 results. Effective July 1, 2014, AMD reorganized into two business groups: Computing and Graphics, which primarily includes desktop and notebook processors and chipsets, discrete GPUs, and professional graphics; and Enterprise, Embedded and Semi-Custom, which primarily includes server and embedded processors, dense servers, semi-custom SoC products (including solutions for gaming consoles), engineering services, and royalties. As part of this restructuring, AMD announced that 7% of its global workforce would be laid off by the end of 2014.<sup>[91]</sup>

# List of CEOs

- 1. Jerry Sanders, 1969–2002 (founder, electrical engineer)
- 2. <u>Hector Ruiz</u>, 2002–2008 (electrical engineer)
- 3. <u>Dirk Meyer</u>, 2008–2011 (<u>computer engineer</u>)
- 4. Rory Read, 2011–2014 (information systems)
- 5. Lisa Su, 2014–present (electrical engineer)

# Products

# **CPUs and APUs**



Early AMD 9080 Processor (AMD AM9080ADC / C8080A), 1977



AMD D8086, 1978 See also: List of AMD microprocessors

#### IBM PC and the x86 architecture

Main articles: Am286, Am386, Am486, and Am5x86

In February 1982, AMD signed a contract with Intel, becoming a licensed second-source manufacturer of <u>8086</u> and <u>8088</u> processors. IBM wanted to use the Intel 8088 in its IBM PC, but IBM's policy at the time was to require at least two sources for its chips. AMD later produced the <u>Am286</u> under the same arrangement. In 1984, Intel, in order to shore up its advantage in the marketplace, internally decided to no longer cooperate with AMD in supplying product information, and delayed and eventually refused to convey the technical details of the Intel <u>80386</u> to AMD.<sup>[92]</sup> In 1987, AMD invoked arbitration over the issue, and Intel reacted by cancelling the 1982 technological-exchange agreement altogether.<sup>[93][94]</sup> After three years of testimony, AMD eventually won in arbitration in 1992, but Intel disputed this decision. Another long legal dispute followed, ending in 1994 when the <u>Supreme Court of California</u> sided with the arbitrator and AMD.<sup>[95][96]</sup>

In 1990, Intel also countersued AMD, renegotiating AMD's right to use derivatives of Intel's <u>microcode</u> for its cloned processors.<sup>[97]</sup> In the face of uncertainty during the legal dispute, AMD was forced to develop <u>clean-room designed</u> versions of Intel code for its x386 and x486 processors, the former long after Intel had released its own x386 in 1985.<sup>[98]</sup> In March 1991, AMD released the <u>Am386</u>, its clone of the Intel 386 processor.<sup>[50]</sup> By October of the same year it had sold one million units.<sup>[50]</sup>

In 1993, AMD introduced the first of the <u>Am486</u> family of processors,<sup>[18]</sup> which proved popular with a large number of <u>original equipment manufacturers</u>, including <u>Compaq</u>, which signed an exclusive agreement using the Am486.<sup>[10][99][100]</sup> Another Am486-based processor, the <u>Am5x86</u>, was released in November 1995 and continued AMD's success as a fast, cost-effective processor.<sup>[101][102]</sup>

Finally, in an agreement effective 1996, AMD received the rights to the microcode in Intel's x386 and x486 processor families, but not the rights to the microcode in the following generations of processors.<sup>[103][104]</sup>

#### K5, K6, Athlon, Duron, and Sempron

Main articles: AMD K5, AMD K6, Athlon, Duron, and Sempron

AMD's first in-house x86 processor was the <u>K5</u>, which was launched in 1996.<sup>[105]</sup> The "K" was a reference to <u>Kryptonite</u>. (In comic books, the only substance which could harm <u>Superman</u> was Kryptonite. This is a reference to Intel's hegemony over the market, i.e., an anthropomorphization of them as Superman.<sup>[106]</sup>) The numeral "5" refers to the fifth generation of x86 processors; rival Intel had previously introduced its line of fifth-generation x86 processors as <u>Pentium</u> because the U.S. Trademark and Patent Office had ruled that mere numbers could not be trademarked.<sup>[107]</sup>

In 1996, AMD purchased <u>NexGen</u>, specifically for the rights to their Nx series of x86compatible processors. AMD gave the NexGen design team their own building, left them alone, and gave them time and money to rework the Nx686. The result was the <u>K6</u> processor, introduced in 1997. Although the K6 was based on <u>Socket 7</u>, variants such as K6-3/450 were faster than Intel's <u>Pentium II</u> (sixth-generation processor).

The K7 was AMD's seventh-generation x86 processor, making its debut on June 23, 1999, under the brand name <u>Athlon</u>. Unlike previous AMD processors, it could not be used on the same motherboards as Intel's, due to licensing issues surrounding Intel's <u>Slot 1</u> connector, and instead used a <u>Slot A</u> connector, referenced to the <u>Alpha</u> processor bus. The <u>Duron</u> was a lower-cost and limited version of the Athlon (64KB instead of 256KB L2 cache) in a 462-pin socketed PGA (socket A) or soldered directly onto the motherboard. <u>Sempron</u> was released as a lower-cost Athlon XP, replacing Duron in the <u>socket A</u> PGA era. It has since been migrated upward to all new sockets, up to <u>AM3</u>.

On October 9, 2001, the <u>Athlon XP</u> was released. On February 10, 2003, the Athlon XP with 512KB L2 Cache was released.<sup>[108]</sup>

#### Athlon 64, Opteron and Phenom

Main articles: Athlon 64, Opteron, and Phenom (processor)

The K8 was a major revision of the K7 architecture, released in 2003, with the most notable features being the addition of a <u>64-bit</u> extension to the x86 instruction set (called <u>x86-64</u>, AMD64, or x64), the incorporation of an on-chip memory controller, and the implementation of an extremely high performance point-to-point interconnect called <u>HyperTransport</u>, as part of the <u>Direct Connect Architecture</u>. The technology was initially launched as the <u>Opteron</u> server-oriented processor on April 22, 2003.<sup>[109]</sup> Shortly thereafter it was incorporated into a product for desktop PCs, branded <u>Athlon 64</u>.<sup>[110]</sup>

On April 21, 2005, AMD released the first <u>dual core Opteron</u>, an x86-based server CPU.<sup>[111]</sup> A month later, AMD released the <u>Athlon 64 X2</u>, the first desktop-based <u>dual core processor</u> family.<sup>[112]</sup> In May 2007, AMD abandoned the string "64" in its dual-core desktop product branding, becoming Athlon X2, downplaying the significance of <u>64-bit computing</u> in its processors. Further updates involved improvements to the microarchitecture, and a shift of target market from mainstream desktop systems to value dual-core desktop systems. In 2008, AMD started to release dual-core Sempron processors exclusively in China, branded as the Sempron 2000 series, with lower HyperTransport speed and smaller L2 cache. Thus AMD completed its dual-core product portfolio for each market segment.

After K8 came <u>K10</u>. In September 2007, AMD released the first server Opteron K10 processors, <sup>[113]</sup> followed in November by the <u>Phenom</u> processor for desktop. K10 processors came in dual-core, <u>triple-core</u>, <sup>[114]</sup> and <u>quad-core</u> versions, with all cores on a single die. AMD released a new platform, codenamed "<u>Spider</u>", which utilized the new Phenom processor, as well as an R770 GPU and a 790 GX/FX chipset from the <u>AMD 700 chipset series</u>. <sup>[115]</sup> However, AMD built the Spider at <u>65nm</u>, which was uncompetitive with Intel's smaller and more power-efficient <u>45nm</u>.

In January 2009, AMD released a new processor line dubbed <u>Phenom II</u>, a refresh of the original <u>Phenom</u> built using the 45 nm process.<sup>[116]</sup> AMD's new platform, codenamed "<u>Dragon</u>", utilized the new Phenom II processor, and an <u>ATI</u> R770 GPU from the <u>R700</u> GPU family, as well as a 790 GX/FX chipset from the <u>AMD 700 chipset series</u>.<sup>[117]</sup> The Phenom II came in dual-core, triple-core and quad-core variants, all using the same die, with cores disabled for the triple-core and dual-core versions. The Phenom II resolved issues that the original Phenom had, including a low clock speed, a small L3 cache and a <u>Cool'n'Quiet</u> bug that decreased performance. The Phenom II cost less but was not performance-competitive with Intel's mid-to-high-range <u>Core 2</u> Quads. The Phenom II also enhanced its predecessor's memory controller, allowing it to use <u>DDR3</u> in a new native socket <u>AM3</u>, while maintaining backwards compatibility with <u>AM2+</u>, the socket used for the Phenom, and allowing the use of the <u>DDR2</u> memory that was used with the platform.

In April 2010, AMD released a new Phenom II hexa-core (6-core) processor codenamed "<u>Thuban</u>".<sup>[118]</sup> This was a totally new die based on the hexa-core "Istanbul" <u>Opteron</u> processor. It included AMD's "turbo core" technology, which allows the processor to automatically switch from 6 cores to 3 faster cores when more pure speed is needed.

The <u>Magny Cours</u> and <u>Lisbon</u> server parts were released in 2010.<sup>[119]</sup> The Magny Cours part came in 8 to 12 cores and the Lisbon part in 4 and 6 core parts. Magny Cours is focused on performance while the Lisbon part is focused on high performance per watt. Magny Cours is an MCM (<u>multi-chip module</u>) with two hexa-core "Istanbul" <u>Opteron</u> parts. This will use a new G34 socket for dual and quad socket processors and thus will be marketed as Opteron 61xx series processors. Lisbon uses C32 socket certified for dual socket use or single socket use only and thus will be marketed as Opteron 41xx processors. Both will be built on a <u>45 nm</u> SOI process.

#### Fusion becomes the AMD APU

Main articles: AMD APU and AMD mobile platform

Following AMD's 2006 acquisition of Canadian graphics company <u>ATI Technologies</u>, an initiative codenamed *Fusion* was announced to integrate a <u>CPU</u> and <u>GPU</u> together on some of AMD's microprocessors, including a built in <u>PCI Express</u> link to accommodate separate PCI Express peripherals, eliminating the <u>northbridge</u> chip from the motherboard. The initiative intended to move some of the processing originally done on the CPU (e.g. <u>floating-point unit</u> operations) to the GPU, which is better optimized for some calculations. The Fusion was later renamed to the <u>AMD APU</u> (Accelerated Processing Unit).<sup>[120]</sup>

Llano was AMD's first APU built for <u>laptops</u>. Llano was the second APU released,<sup>[121]</sup> targeted at the mainstream market.<sup>[120]</sup> Incorporating a CPU and GPU on the same die, as well as northbridge functions, and using "<u>Socket FM1</u>" with <u>DDR3</u> memory. The CPU part of the processor was based on the <u>Phenom II</u> "Deneb" processor. AMD suffered an unexpected decrease in revenue based on production problems for the Llano.<sup>[122]</sup>

#### New microarchitectures

#### High-power, high-performance Bulldozer cores

Main articles: <u>Bulldozer microarchitecture</u>, <u>Piledriver microarchitecture</u>, <u>Steamroller microarchitecture</u>, and <u>Excavator microarchitecture</u>

Bulldozer was AMD's microarchitecture codename for server and desktop <u>AMD FX</u> processors first released on October 12, 2011. This <u>family 15h microarchitecture</u> is the successor to the <u>family 10h (K10)</u> microarchitecture design. Bulldozer was a clean-sheet design, not a development of earlier processors.<sup>[123]</sup> The core was specifically aimed at 10–125 <u>W TDP</u> computing products. AMD claimed dramatic performance-per-watt efficiency improvements in <u>high-performance computing</u> (HPC) applications with Bulldozer cores. While hopes were high that Bulldozer would bring AMD to be performance-competitive with Intel once more, most benchmarks were disappointing. In some cases the new Bulldozer products were slower than the K10 models they were built to replace.<sup>[124][125][126]</sup>

The <u>Piledriver microarchitecture</u> was the 2012 successor to Bulldozer, increasing clock speeds and performance relative to its predecessor.<sup>[127]</sup> Piledriver would be released in AMD FX, APU, and Opteron product lines.<sup>[128][129][130][131]</sup> Piledriver was subsequently followed by the <u>Steamroller microarchitecture</u> in 2013. Used exclusively in AMD's APUs, Steamroller focused on greater parallelism.<sup>[132][133]</sup>

In 2015, the <u>Excavator microarchitecture</u> replaced Piledriver.<sup>[134]</sup> Expected to be the last microarchitecture of the Bulldozer series,<sup>[135][136]</sup> Excavator focused on improved power efficiency.<sup>[137]</sup>

#### Low-power Cat cores

Main articles: Bobcat microarchitecture, Jaguar microarchitecture, and Puma microarchitecture

The <u>Bobcat microarchitecture</u> was revealed during a speech from AMD executive vice-president Henri Richard in <u>Computex</u> 2007 and was put into production Q1 2011.<sup>[121]</sup> Based on the difficulty competing in the x86 market with a single core optimized for the 10–100 W range, AMD had developed a simpler core with a target range of 1–10 watts.<sup>[138]</sup> In addition, it was believed that the core could migrate into the hand-held space if the power consumption can be reduced to less than 1 W.<sup>[139]</sup>

Jaguar is a microarchitecture codename for Bobcat's successor, released in 2013, that is used in various APUs from AMD aimed at the low-power/low-cost market.<sup>[140]</sup> Jaguar and its derivates would go on to be used in the custom APUs of the <u>PlayStation 4</u>,<sup>[141][142]</sup> <u>Xbox One</u>,<sup>[143][144]</sup> <u>PlayStation 4 Pro</u>,<sup>[145][146][147]</sup> <u>Xbox One S</u>,<sup>[148]</sup> and <u>Xbox One X</u>.<sup>[149][150]</sup> Jaguar would be later followed by the <u>Puma microarchitecture</u> in 2014.<sup>[151]</sup>

#### ARM architecture-based designs

In 2012, AMD announced it was working on an <u>ARM architecture</u> products, both as a semicustom product and server product.<sup>[152][153][154]</sup> The initial server product was announced at the <u>Opteron A1100</u> in 2014, and 8-core <u>Cortex-A57</u> based <u>ARMv8-A SoC</u>,<sup>[155][156]</sup> and was expected to be followed by an APU incorporating a Graphic Core Next GPU.<sup>[157]</sup> However, the Opteron A1100 was not released until 2016, with the delay attributed to adding software support.<sup>[158]</sup> The A1100 was also criticized for not having support from major vendors upon its release.<sup>[158][159][160]</sup>

In 2014, AMD also announced the <u>K12</u> custom core for release in 2016.<sup>[161]</sup> While being <u>ARMv8-A</u> instruction set architecture compliant, the K12 is expected to be entirely custom designed targeting server, embedded, and semi-custom markets. While ARM architecture development continued, products based on K12 were subsequently delayed with no release planned, in preference to the development of AMD's x86 based Zen microarchitecture.<sup>[162][163]</sup>

#### Zen based CPUs and APUs

#### Main articles: Zen (microarchitecture), Zen+, and Zen 2

Zen is a new architecture for x86-64 based <u>Ryzen series</u> CPUs and APUs, introduced in 2017 by AMD and built from the ground up by a team led by <u>Jim Keller</u>, beginning with his arrival in 2012, and <u>taping out</u> before his departure in September 2015. One of AMD's primary goals with Zen was an <u>IPC</u> increase of at least 40%, however in February 2017 AMD announced that they had actually achieved a 52% increase. <sup>[164][failed verification]</sup> Processors made on the Zen architecture are built on the 14 nm FinFET node and have a renewed focus on single-core performance and <u>HSA</u> compatibility. <sup>[165]</sup> Previous processors from AMD were either built in the 32 nm process ("Bulldozer" and "Piledriver" CPUs) or the 28 nm process ("Steamroller" and "Excavator" APUs). Because of this, Zen is much more energy efficient. The Zen architecture is the first to encompass CPUs and APUs from AMD built for a single socket (Socket AM4). Also new for this architecture is the implementation of simultaneous multithreading (SMT) technology, something Intel has had for years on some of their processors with their proprietary <u>Hyper-Threading</u> implementation of SMT. This is a departure from the "<u>Clustered MultiThreading</u>" design introduced with the Bulldozer architecture. Zen also has support for <u>DDR4</u> memory. AMD released the Zen-based high-end Ryzen 7 "Summit Ridge" series CPUs on March 2,

2017,<sup>[166]</sup> mid-range Ryzen 5 series CPUs on April 11, 2017, and entry level Ryzen 3 series CPUs on July 27, 2017.<sup>[167]</sup> AMD later released the Epyc line of Zen derived server processors for 1P and 2P systems.<sup>[168]</sup> In October 2017, AMD released Zen based APUs as Ryzen Mobile, incorporating Vega graphics cores.<sup>[169]</sup> In January 2018 AMD has announced their new lineup plans, with Ryzen 2.<sup>[170]</sup> AMD launched CPUs with the <u>12nm Zen+<sup>[171]</sup></u> microarchitecture in April 2018, following up with the <u>7nm Zen 2</u> microarchitecture in June 2019, including an update to the Epyc line with new processors using the Zen 2 microarchitecture in August 2019. As of 2019, AMD's Ryzen processors are reported to outsell Intel's consumer desktop processors.<sup>[172]</sup>

# **Graphics products and GPUs**

### ATI prior to AMD acquisition

Main article: ATI Technologies

Lee Ka Lau,<sup>[173]</sup> Francis Lau, Benny Lau, and Kwok Yuen Ho<sup>[174]</sup> founded ATI in 1985 as Array Technology Inc.<sup>[175]</sup> Working primarily in the <u>OEM</u> field, ATI produced integrated graphics cards for PC manufacturers such as <u>IBM</u> and <u>Commodore</u>. By 1987, ATI had grown into an independent graphics-card retailer, introducing EGA Wonder and VGA Wonder card product lines that year.<sup>[176]</sup> In the early nineties, they released products able to process graphics without the CPU: in May 1991, the Mach8, in 1992 the Mach32, which offered improved memory bandwidth and <u>GUI</u> acceleration. ATI Technologies Inc. went public in 1993, with shares listed on <u>NASDAQ</u> and on the <u>Toronto Stock Exchange</u>.



ATI's former Silicon Valley office



ATI "Graphics Solution Rev 3" from 1985/1986, supporting <u>Hercules</u> graphics. As the <u>PCB</u> reveals, the layout dates from 1985, whereas the marking on the central chip *CW16800-A* says "8639" - meaning that chip was manufactured in week 39, 1986. Notice <u>UM6845E CRT</u> <u>controller</u>. This card uses the <u>ISA 8-bit interface</u>.



ATI VGA Wonder with 256 KB RAM

In 1994, the Mach64 accelerator debuted, powering the Graphics Xpression and Graphics Pro Turbo, offering hardware support for <u>YUV</u>-to-<u>RGB color space</u> conversion in addition to hardware zoom; early techniques of hardware-based video acceleration.

ATI introduced its first combination of 2D and <u>3D</u> accelerator under the name <u>3D Rage</u>. This chip was based on the Mach 64, but it featured elemental 3D acceleration. The ATI Rage line powered almost the entire range of ATI graphics products. In particular, the <u>Rage Pro</u> was one of the first viable 2D-plus-3D alternatives to <u>3Dfx</u>'s 3D-only Voodoo chipset. 3D acceleration in the Rage line advanced from the basic functionality within the initial 3D Rage to a more advanced <u>DirectX 6.0</u> accelerator in 1999 <u>Rage 128</u>.

The <u>All-in-Wonder</u> product line, introduced in 1996, was the first combination of integrated graphics chip with <u>TV tuner card</u> and the first chip that enabled display of computer graphics on a TV set.<sup>[177]</sup> The cards featured 3D acceleration powered by ATI's 3D Rage **II**, 64-bit 2D performance, TV-quality video acceleration, analog video capture, TV tuner functionality, flicker-free TV-out and stereo TV audio reception.

ATI entered the mobile computing sector by introducing 3D-graphics acceleration to laptops in 1996. The Mobility product line had to meet requirements different from those of desktop PCs, such as minimized power usage, reduced heat output, <u>TMDS</u> output capabilities for laptop

screens, and maximized integration. In 1997, ATI acquired <u>Tseng Labs</u>'s graphics assets, which included 40 engineers.

The <u>Radeon</u> line of graphics products was unveiled in 2000. The initial Radeon <u>graphics</u> <u>processing unit</u> offered an all-new design with DirectX 7.0 3D acceleration, video acceleration, and 2D acceleration. Technology developed for a specific Radeon generation could be built in varying levels of features and performance in order to provide products suited for the entire market range, from high-end to budget to mobile versions.

In 2000, ATI acquired <u>ArtX</u>, which engineered the <u>Flipper</u> graphics chip used in the <u>Nintendo</u> <u>GameCube</u> game console. They also created a modified version of the chip (codenamed <u>Hollywood</u>) for the successor of the <u>GameCube</u>, the <u>Wii</u>. <u>Microsoft</u> contracted ATI to design the graphics core (codenamed <u>Xenos</u>) for the <u>Xbox 360</u>. Later in 2005, ATI acquired <u>Terayon's</u> cable modem <u>silicon intellectual property</u>, strengthening their lead in the consumer digital television market.<sup>[178]</sup> K. Y. Ho remained as Chairman of the Board until he retired in November 2005. <u>Dave Orton</u> replaced him as the President and CEO of the organization.

On July 24, 2006, a joint announcement revealed that Advanced Micro Devices would <u>acquire</u> ATI in a deal valued at \$5.6 billion.<sup>[179]</sup> The acquisition consideration closed on October 25, 2006,<sup>[180]</sup> and included over \$2 billion financed from a loan and 56 million shares of AMD stock.<sup>[181]</sup> ATI's operations became part of the AMD Graphics Product Group (GPG),<sup>[182]</sup> and ATI's CEO Dave Orton became the Executive Vice President of Visual and Media Businesses at AMD until his resignation in 2007.<sup>[183]</sup> The top-level management was reorganized with the Senior Vice President and General Manager, and the Senior Vice President and General Manager of Consumer Electronics Group, both of whom would report to the CEO of AMD.<sup>[184]</sup> On 30 August 2010, John Trikola announced that AMD would retire the ATI brand for its graphics chipsets in favor of the AMD name.<sup>[185]</sup>

#### **Radeon within AMD**

#### Main article: Radeon

In 2008, the ATI division of AMD released the <u>TeraScale microarchitecture</u> implementing a <u>unified shader model</u>. This design replaced the previous fixed-function hardware of previous graphics cards with multipurpose, programmable shaders. Initially released as part of the GPU for the <u>Xbox 360</u>, this technology would go on to be used in Radeon branded HD 2000 parts. Three generations of TeraScale would be designed and used in parts from 2008-2014.

#### Combined GPU and CPU divisions

In a 2009 restructuring, AMD merged the CPU and GPU divisions to support the companies APU's which fused both graphics and general purpose processing.<sup>[186][187]</sup> In 2011, AMD released the successor to TeraScale, <u>Graphics Core Next (GCN)</u>.<sup>[188]</sup> This new microarchitecture emphasized <u>GPGPU</u> compute capability in addition to graphics processing, with a particular aim

of supporting heterogeneous computing on AMD's APUs. GCN's <u>reduced instruction set ISA</u> allowed for significantly increased compute capability over TeraScale's <u>very long instruction</u> word ISA. Since GCN's introduction with the <u>HD 7970</u>, five generations of the GCN architecture have been produced from 2008 through at least 2017.<sup>[189]</sup>

#### **Radeon Technologies Group**

Main article: Radeon Technologies Group

In September 2015, AMD separated the graphics technology division of the company into an independent internal unit called the **Radeon Technologies Group** (RTG) headed by <u>Raja</u> <u>Koduri</u>.<sup>[190]</sup> This gave the graphics division of AMD autonomy in product design and marketing.<sup>[191][192]</sup> The RTG then went on to create and release the <u>Polaris</u> and <u>Vega</u> microarchitectures released in 2016 and 2017, respectively.<sup>[193][194]</sup> In particular the Vega, or 5th generation <u>GCN</u>, microarchitecture includes a number of major revisions to improve performance and compute capabilities.<sup>[195][196]</sup>

In November 2017, Raja Koduri left RTG <sup>[197]</sup> and CEO and President Lisa Su took his position. In January 2018, it was reported that two industry veterans joined RTG, namely <u>Mike Rayfield</u> as senior vice president and general manager of RTG, and <u>David Wang</u> as senior vice president of engineering for RTG. <sup>[198]</sup> As of January 2020, AMD develops the second generation <u>RDNA</u> graphics architecture with the aim to take on the NVIDIA RTX graphics products performance leadership.

#### Semi-custom and game console products

In 2012, AMD's then CEO <u>Rory Read</u> began a program to offer semi-custom designs.<sup>[199][200]</sup> Rather than AMD simply designing and offering a single product, potential customers could work with AMD to design a custom chip based on AMD's intellectual property. Customers pay a non-recurring engineering fee for design and development, and a purchase price for the resulting semi-custom products. In particular, AMD noted their unique position of offering both x86 and graphics intellectual property. These semi-custom designs would have design wins as the APUs in the <u>PlayStation 4</u> and <u>Xbox One</u> and the subsequent <u>PlayStation 4 Pro, Xbox One S</u>, and <u>Xbox</u> <u>One X</u>.<sup>[147][150][201]</sup> Financially, these semi-custom products would represent a majority of the company's revenue in 2016.<sup>[202][203]</sup> In November 2017, AMD and Intel announced that Intel would market a product combining in a single package an Intel Core CPU, a semi-custom AMD Radeon GPU, and <u>HBM2</u> memory.<sup>[204]</sup>

# **Other hardware**

#### AMD motherboard chipsets

#### See also: Comparison of AMD chipsets

Before the launch of <u>Athlon 64</u> processors in 2003, AMD designed <u>chipsets</u> for their processors spanning the <u>K6</u> and <u>K7</u> processor generations. The chipsets include the AMD-640, AMD-751

and the AMD-761 chipsets. The situation changed in 2003 with the release of <u>Athlon 64</u> processors, and AMD chose not to further design its own chipsets for its desktop processors while opening the desktop platform to allow other firms to design chipsets. This was the "<u>Open Platform Management Architecture</u>" with <u>ATI</u>, <u>VIA</u> and <u>SiS</u> developing their own chipset for <u>Athlon 64</u> processors and later <u>Athlon 64 X2</u> and <u>Athlon 64 FX</u> processors, including the <u>Quad FX platform</u> chipset from Nvidia.

The initiative went further with the release of <u>Opteron</u> server processors as AMD stopped the design of server chipsets in 2004 after releasing the AMD-8111 chipset, and again opened the server platform for firms to develop chipsets for Opteron processors. As of today, <u>Nvidia</u> and <u>Broadcom</u> are the sole designing firms of server chipsets for Opteron processors.

As the company completed the acquisition of ATI Technologies in 2006, the firm gained the ATI design team for chipsets which previously designed the <u>Radeon Xpress 200</u> and the <u>Radeon Xpress 3200</u> chipsets. AMD then renamed the chipsets for AMD processors under AMD branding (for instance, the CrossFire Xpress 3200 chipset was renamed as <u>AMD 580X CrossFire chipset</u>). In February 2007, AMD announced the first AMD-branded chipset since 2004 with the release of the AMD <u>690G</u> chipset (previously under the development codename *RS690*), targeted at mainstream <u>IGP</u> computing. It was the industry's first to implement a <u>HDMI</u> 1.2 port on motherboards, shipping for more than a million units. While ATI had aimed at releasing an Intel IGP chipset, the plan was scrapped and the inventories of <u>Radeon Xpress 1250</u> (codenamed *RS600*, sold under ATI brand) was sold to two OEMs, Abit and ASRock. Although AMD stated the firm would still produce Intel chipsets, Intel had not granted the license of 1333 MHz FSB to ATI.

On November 15, 2007, AMD announced a new chipset series portfolio, the <u>AMD 7-Series</u> chipsets, covering from enthusiast multi-graphics segment to value IGP segment, to replace the <u>AMD 480/570/580 chipsets</u> and <u>AMD 690 series chipsets</u>, marking AMD's first enthusiast multi-graphics chipset. Discrete graphics chipsets were launched on November 15, 2007, as part of the codenamed *Spider* desktop platform, and IGP chipsets were launched at a later time in spring 2008 as part of the codenamed *Cartwheel* platform.

AMD returned to the server chipsets market with the <u>AMD 800S series server chipsets</u>. It includes support for up to six <u>SATA 6.0 Gbit/s</u> ports, the C6 power state, which is featured in <u>Fusion</u> processors and <u>AHCI 1.2 with SATA FIS-based switching</u> support. This is a chipset family supporting <u>Phenom</u> processors and <u>Quad FX enthusiast platform</u> (890FX), <u>IGP</u>(890GX).

With the advent of AMD's APUs in 2011, traditional north bridge features such as the connection to graphics and the PCI Express controller were incorporated into the APU die. Accordingly, APUs were connected to as single chip chipset, renamed the Fusion Controller Hub (FCH), which primarily provided southbridge functionality.<sup>[205]</sup>

AMD released new chipsets in 2017 to support the release of their new <u>Ryzen</u> products. As the <u>Zen microarchitecture</u> already includes much of the northbridge connectivity, the AM4 based chipsets primarily varied in the number of additional PCI Express lanes, USB connections, and

SATA connections available.<sup>[206]</sup> These AM4 chipsets were designed in conjunction with <u>ASMedia</u>.<sup>[207]</sup>

#### **Embedded products**

#### **Embedded CPUs**

Main articles: Alchemy (processor) and Geode (processor)

In February 2002, AMD acquired Alchemy Semiconductor for its <u>Alchemy</u> line of <u>MIPS</u> processors for the hand-held and <u>portable media player</u> markets.<sup>[208]</sup> On June 13, 2006, AMD officially announced that the line was to be transferred to Raza Microelectronics, Inc., a designer of MIPS processors for embedded applications.<sup>[209]</sup>

In August 2003, AMD also purchased the <u>Geode</u> business which was originally the <u>Cyrix</u> <u>MediaGX</u> from <u>National Semiconductor</u> to augment its existing line of embedded x86 processor products.<sup>[210]</sup> During the second quarter of 2004, it launched new low-power Geode NX processors based on the K7 Thoroughbred architecture with speeds of fanless processors 667 MHz and 1 GHz, and 1.4 GHz processor with fan, of <u>TDP</u> 25 W. This technology is used in a variety of embedded systems (Casino slot machines and customer kiosks for instance), several <u>UMPC</u> designs in Asia markets, as well as the <u>OLPC XO-1 computer</u>, an inexpensive laptop computer intended to be distributed to children in developing countries around the world.<sup>[211]</sup> The Geode LX processor was announced in 2005 and is said will continue to be available through 2015.

AMD has also introduced <u>64-bit</u> processors into its embedded product line starting with the AMD <u>Opteron</u> processor. Leveraging the high throughput enabled through <u>HyperTransport</u> and the <u>Direct Connect Architecture</u> these server class processors have been targeted at high-end telecom and storage applications. In 2007, AMD added the AMD Athlon, <u>AMD Turion</u>, and Mobile AMD Sempron processors to its embedded product line. Leveraging the same <u>64-bit</u> instruction set and <u>Direct Connect Architecture</u> as the AMD <u>Opteron</u> but at lower power levels, these processors were well suited to a variety of traditional embedded applications. Throughout 2007 and into 2008, AMD has continued to add both single-core Mobile AMD Sempron and AMD Athlon processors and <u>dual-core</u> AMD Athlon X2 and AMD Turion processors to its embedded product line and now offers embedded <u>64-bit</u> solutions starting with 8W TDP Mobile AMD Sempron and AMD Athlon processors for fan-less designs up to multi-processor systems leveraging multi-core AMD Opteron processors all supporting longer than standard availability.<sup>[212]</sup>

The ATI acquisition in 2006 included the <u>Imageon</u> and <u>Xilleon</u> product lines. In late 2008, the entire handheld division was sold off to <u>Qualcomm</u>, who have since produced the <u>Adreno</u> series.<sup>[213]</sup> Also in 2008, the Xilleon division was sold to <u>Broadcom</u>.<sup>[214][215]</sup>

In April 2007, AMD announced the release of the <u>M690T</u> integrated graphics chipset for embedded designs. This enabled AMD to offer complete processor and chipset solutions targeted at embedded applications requiring high-performance 3D and video such as emerging digital signage, kiosk and Point of Sale applications. The M690T was followed by the <u>M690E</u>

specifically for embedded applications which removed the TV output, which required <u>Macrovision</u> licensing for OEMs, and enabled native support for dual <u>TMDS</u> outputs, enabling dual independent <u>DVI</u> interfaces.<sup>[citation needed]</sup>

In January 2011, AMD announced the AMD Embedded G-Series <u>Accelerated Processing</u> <u>Unit</u>.<sup>[216][217]</sup> This was the first APU for embedded applications. These were followed by updates to the in 2013 and 2016.<sup>[218][219]</sup>

In May 2012, AMD Announced the AMD Embedded R-Series <u>Accelerated Processing Unit</u>.<sup>[220]</sup> This family of products incorporates the Bulldozer CPU architecture, and Discrete-class Radeon HD 7000G Series graphics. This was followed by a <u>system on a chip (SoC)</u> version in 2015 which offered a faster CPU and faster graphics, with support for <u>DDR4 SDRAM</u> memory.<sup>[221][222]</sup>

#### **Embedded graphics**

AMD builds graphic processors for use in <u>embedded</u> systems. They can be found in anything from casinos to healthcare, with a large portion of products being used in industrial machines.<sup>[223]</sup> These products include a complete graphics processing device in a compact <u>multi-chip module</u> including RAM and the GPU.<sup>[224]</sup> ATI began offering embedded GPUs with the E2400 in 2008. Since that time AMD has released regular updates to their embedded GPU lineup in 2009, 2011, 2015, and 2016; reflecting improvements in their GPU technology.<sup>[224][225][226][227]</sup>

### **Current product lines**

#### **CPU and APU products**

AMD's portfolio of CPUs and APUs as of 2018

- <u>Athlon</u> brand of entry level APUs
- **<u>Ryzen</u>** brand of consumer CPUs and APUs
- Threadripper brand of prosumer/professional CPUs
- **<u>Epyc</u>** brand of server CPUs

#### **Graphics products**

AMD's portfolio of dedicated graphics processors as of 2017

- <u>Radeon</u> brand for consumer line of graphics cards; the brand name originated with ATI.
  - <u>Mobility Radeon</u> offers power-optimized versions of Radeon graphics chips for use in laptops.
- <u>Radeon Pro</u> Workstation Graphics card brand. Successor to the <u>FirePro</u> brand.
- **<u>Radeon Instinct</u>** brand of server and workstation targeted machine learning and <u>GPGPU</u> products

# **Radeon-branded products**

# RAM



AMD Radeon memory

In 2011, AMD began selling Radeon branded <u>DDR3 SDRAM</u> to support the higher bandwidth needs of AMD's APUS.<sup>[228]</sup> While the RAM is sold by AMD, it was manufactured by <u>Patriot</u> <u>Memory</u> and VisionTek. This was later followed by higher speeds of gaming oriented DDR3 memory in 2013.<sup>[229]</sup> Radeon branded <u>DDR4 SDRAM</u> memory was released in 2015, despite no AMD CPUs or APUs supporting DDR4 at the time.<sup>[230]</sup> AMD noted in 2017 that these products are "mostly distributed in Eastern Europe" and that it continues to be active in the business.<sup>[231]</sup>

### Solid-state drives

AMD announced in 2014 it would sell Radeon branded <u>solid-state drives</u> manufactured by <u>OCZ</u> with capacities up to 480 GB and using the <u>SATA</u> interface.<sup>[232]</sup> This was followed in 2016 by updated drives of up to 960 GB,<sup>[233]</sup> with <u>M.2/NVMe</u> drives expected later.<sup>[234]</sup>

# Technologies

# **CPU technologies**

As of 2017 technologies found in AMD CPU/APU products include:

- <u>HyperTransport</u> a high-bandwidth, low-latency system bus used in AMD's CPU and APU products
- <u>Infinity Fabric</u> a derivative of HyperTransport used as the communication bus in AMD's <u>Zen microarchitecture</u>

# **Graphics technologies**

As of 2017 technologies found in AMD GPU products include:

- <u>AMD Eyefinity</u> facilitates <u>multi-monitor</u> setup of up to 6 monitors per graphics card
- <u>AMD FreeSync</u> display synchronization based on the <u>VESA</u> Adaptive Sync standard
- <u>AMD TrueAudio</u> acceleration of audio calculations

- AMD XConnect allows the use of External GPU enclosures through Thunderbolt 3
- <u>AMD CrossFire</u> multi-GPU technology allowing the simultaneous use of multiple GPUs
- <u>Unified Video Decoder</u> (UVD) acceleration of video decompression (decoding)
- <u>Video Coding Engine</u> (VCE) acceleration of video compression (encoding)

### Software

- <u>AMD Catalyst</u> is a collection of <u>proprietary device driver</u> software available for <u>Microsoft Windows</u> and <u>Linux</u>.
- <u>AMDGPU</u> is AMD's <u>open source device driver</u> supporting the <u>GCN</u> architecture, available for Linux.
- AMD develops the <u>AMD CodeXL</u> tool suite which includes a GPU debugger, a GPU profiler, a CPU profiler and an OpenCL static kernel analyzer. CodeXL is freely available at AMD developer tools website.
- <u>AMD Stream SDK</u> and <u>AMD APP SDK</u> (Accelerated Parallel Processing) SDK to enable AMD graphics processing cores (GPU), working in concert with the system's x86 cores (CPU), to execute heterogeneously to accelerate many applications beyond just graphics<sup>[235]</sup>
- AMD has also taken an active part in developing <u>coreboot</u>, an open source project aimed at replacing the proprietary BIOS firmware. This cooperation ceased in 2013, but AMD has indicated recently that it is considering releasing source code so that Ryzen can be compatible with coreboot in the future.<sup>[236]</sup>
- Other AMD software includes the <u>AMD Core Math Library</u>, and open-source software including the <u>AMD Performance Library</u>, and the <u>CodeAnalyst</u> performance profiler.
- AMD contributes to <u>open source</u> projects, including working with <u>Sun Microsystems</u> to enhance <u>OpenSolaris</u> and <u>Sun xVM</u> on the AMD platform.<sup>[237]</sup> AMD also maintains its own <u>Open64</u> compiler distribution and contributes its changes back to the community.<sup>[238]</sup>
- In 2008, AMD released the low-level programming specifications for its <u>GPUs</u>, and works with the <u>X.Org Foundation</u> to develop drivers for AMD graphics cards.
- Extensions for software parallelism (xSP), aimed at speeding up programs to enable multi-threaded and multi-core processing, announced in Technology Analyst Day 2007. One of the initiatives being discussed since August 2007 is the Light Weight Profiling (LWP), providing internal hardware monitor with runtimes, to observe information about executing process and help the re-design of software to be optimized with multi-core and even multi-threaded programs. Another one is the extension of Streaming SIMD Extension (SSE) instruction set, the <u>SSE5</u>.
- Codenamed *SIMFIRE* interoperability testing tool for the Desktop and mobile Architecture for System Hardware (DASH) <u>open architecture</u>.

# **Production and fabrication**

Main article: GlobalFoundries

Previously, AMD produced its chips at company owned <u>semiconductor foundries</u>. AMD pursued a strategy of collaboration with other semiconductor manufacturers <u>IBM</u> and <u>Motorola</u> to co-

develop production technologies.<sup>[241][242]</sup> AMD's founder Jerry Sanders termed this the "Virtual Gorilla" strategy to compete with Intel's significantly greater investments in fabrication.<sup>[243]</sup>

In 2008, AMD spun off its chip foundries into an independent company named <u>GlobalFoundries</u>.<sup>[244]</sup> This break-up of the company was attributed to the increasing costs of each process node. The <u>Emirate of Abu Dhabi</u> purchased the newly created company through its subsidiary <u>Advanced Technology Investment Company</u> (ATIC), purchasing the final stake from AMD in 2009.<sup>[245]</sup>

With the spin-off of its foundries, AMD became a <u>fabless</u> semiconductor manufacturer, designing products to be produced at for-hire foundries. Part of the GlobalFoundries spin-off included an agreement with AMD to produce some number of products at GlobalFoundries.<sup>[246]</sup> Both prior to the spin-off and after AMD has pursued production with other foundries including <u>TSMC</u> and <u>Samsung</u>.<sup>[247][248]</sup> It has been argued that this would reduce risk for AMD by decreasing dependence on any one foundry which has caused issues in the past.<sup>[248][249]</sup>

# **Corporate affairs**

# Partnerships

AMD utilizes strategic industry partnerships to further its business interests as well as to rival Intel's dominance and resources:<sup>[241][242][243]</sup>

- A partnership between AMD and Alpha Processor Inc. developed <u>HyperTransport</u>, a point-to-point interconnect standard which was turned over to an industry standards body for finalization.<sup>[250]</sup> It is now used in modern motherboards that are compatible with AMD processors.
- AMD also formed a strategic partnership with IBM, under which AMD gained <u>silicon on</u> insulator (SOI) manufacturing technology, and detailed advice on <u>90 nm</u> implementation. AMD announced that the partnership would extend to 2011 for <u>32 nm</u> and <u>22 nm</u> fabrication-related technologies.<sup>[251]</sup>
- To facilitate processor distribution and sales, AMD is loosely partnered with end-user companies, such as <u>HP</u>, <u>Dell</u>, <u>Asus</u>, <u>Acer</u>, and <u>Microsoft</u>.<sup>[252]</sup>
- In 1993, AMD established a 50–50 partnership with <u>Fujitsu</u> called FASL, and merged into a new company called FASL LLC in 2003. The joint venture went public under the name <u>Spansion</u> and ticker symbol SPSN in December 2005, with AMD shares drop to 37%. AMD no longer directly participates in the Flash memory devices market now as AMD entered into a non-competition agreement, as of December 21, 2005, with Fujitsu and Spansion, pursuant to which it agreed not to directly or indirectly engage in a business that manufactures or supplies standalone semiconductor devices (including single chip, multiple chip or system devices) containing only Flash memory.<sup>[253]</sup>
- On May 18, 2006, Dell announced that it would roll out new servers based on AMD's Opteron chips by year's end, thus ending an exclusive relationship with Intel.<sup>[254]</sup> In September 2006, Dell began offering AMD Athlon X2 chips in their desktop lineup.

- In June 2011, HP announced new business and consumer notebooks equipped with the latest versions of AMD APUs accelerated processing units. AMD will power HP's Intel-based business notebooks as well.<sup>[255]</sup>
- In the spring of 2013, AMD announced that it would be powering <u>all three major next-generation consoles</u>.<sup>[256]</sup> The <u>Xbox One</u> and <u>Sony PlayStation 4</u> are both powered by a custom-built AMD APU, and the <u>Nintendo Wii U</u> is powered by an AMD GPU.<sup>[257]</sup> According to AMD, having their processors in all three of these consoles will greatly assist developers with cross-platform development to competing consoles and PCs as well as increased support for their products across the board.<sup>[258]</sup>
- AMD has entered into an agreement with Hindustan Semiconductor Manufacturing Corporation (HSMC) for the production of AMD products in <u>India</u>.<sup>[259]</sup>
- AMD is a founding member of the <u>HSA Foundation</u> which aims to ease the use of a <u>Heterogeneous System Architecture</u>. A Heterogeneous System Architecture is intended to use both <u>central processing units</u> and <u>graphics processors</u> to complete computational tasks.<sup>[260]</sup>
- AMD announced in 2016 that <u>it was creating a joint venture</u> to produce x86 server chips for the Chinese market.<sup>[261]</sup>

# Litigation with Intel

See also: Intel Corp. v. Advanced Micro Devices, Inc. and Advanced Micro Devices, Inc. v. Intel Corp.



AMD processor with Intel logo

AMD has a long history of litigation with former (and current) partner and x86 creator Intel. [262][263][264]

- In 1986, Intel broke an agreement it had with AMD to allow them to produce Intel's micro-chips for <u>IBM</u>; AMD filed for <u>arbitration</u> in 1987 and the arbitrator decided in AMD's favor in 1992. Intel disputed this, and the case ended up in the <u>Supreme Court of California</u>. In 1994, that court upheld the arbitrator's decision and awarded damages for breach of contract.
- In 1990, Intel brought a copyright infringement action alleging illegal use of its 287 microcode. The case ended in 1994 with a jury finding for AMD and its right to use Intel's microcode in its microprocessors through the 486 generation.
- In 1997, Intel filed suit against AMD and <u>Cyrix</u> Corp. for misuse of the term <u>MMX</u>. AMD and Intel settled, with AMD acknowledging MMX as a trademark owned by Intel, and with Intel granting AMD rights to market the AMD K6 MMX processor.

- In 2005, following an investigation, the Japan Federal Trade Commission found Intel guilty on a number of violations. On June 27, 2005, AMD won an <u>antitrust</u> suit against Intel in Japan, and on the same day, AMD filed a broad antitrust complaint against Intel in the U.S. Federal District Court in <u>Delaware</u>. The complaint alleges systematic use of secret rebates, special discounts, threats, and other means used by Intel to lock AMD processors out of the global market. Since the start of this action, the court has issued <u>subpoenas</u> to major computer manufacturers including <u>Acer</u>, <u>Dell</u>, <u>Lenovo</u>, <u>HP</u> and <u>Toshiba</u>.
- In November 2009, Intel agreed to pay AMD \$1.25bn and renew a five-year patent crosslicensing agreement as part of a deal to settle all outstanding legal disputes between them.<sup>[265]</sup>

# **Guinness World Record achievement**

- On August 31, 2011, in Austin, Texas, AMD achieved a <u>Guinness World Record</u> for the "Highest frequency of a computer processor": 8.429 GHz.<sup>[266]</sup> The company ran an 8-core FX-8150 processor with only one active module (two cores), and cooled with liquid helium.<sup>[267]</sup> The previous record was 8.308 GHz, with an Intel Celeron 352 (one core).
- On November 1, 2011, geek.com reported that Andre Yang, an <u>overclocker</u> from Taiwan, used an FX-8150 to set another record: 8.461 GHz.<sup>[268]</sup>
- On November 19, 2012, Andre Yang used an FX-8350 to set another record: 8.794 GHz.<sup>[269]</sup>

#### **Corporate social responsibility**

• In its 2012 report on progress relating to <u>conflict minerals</u>, the <u>Enough Project</u> rated AMD the fifth most progressive of 24 consumer electronics companies.<sup>[270]</sup>